

Technical documentation



Support & training



CD54HC4511, CD74HC4511, CD74HCT4511 SCHS279E – DECEMBER 1998 – REVISED AUGUST 2022

# CDx4HC4511, CD74HCT4511 BCD-to-7 Segment Latch/Decoder/Drivers

## 1 Features

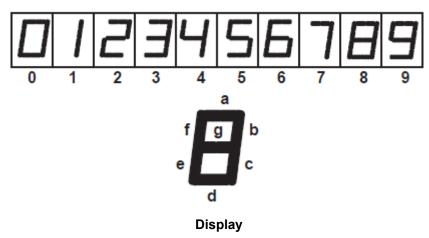
- 2-V to 6-V V<sub>CC</sub> operation ('HC4511)
- 4.5-V to 5.5-V V<sub>CC</sub> operation (CD74HCT4511)
- High-output sourcing capability
  - 7.5 mA at 4.5 V (CD74HCT4511)
    10 mA at 6 V ('HC4511)
- Input latches for BCD code storage
- Lamp test and blanking capability
- · Balanced propagation delays and transition times
- Significant power reduction compared to LSTTL logic IC's
- 'HC4511
  - High noise immunity,
  - $N_{IL}$  or  $N_{IH}$  = 30% of  $V_{CC}$  at  $V_{CC}$  = 5 V
- CD74HCT4511
  - Direct LSTTL input logic compatibility,  $V_{IL}$  = 0.8 V Maximum,  $V_{IH}$  = 2 V minimum
  - CMOS input compatibility,  $I_I \le 1_{\mu A}$  at  $V_{OL}$ ,  $V_{OH}$

## 2 Description

The CD54HC4511, CD74HC4511, and CD74HCT4511 are BCD-to-7 segment latch/decoder/ drivers with four address inputs  $(D_0-D_3)$ , an active-low blanking (BL) input, lamp-test (LT) input, and a latch-enable (LE) input that, when high, enables the latches to store the BCD inputs. When LE is low, the latches are disabled, making the outputs transparent to the BCD inputs.

| Dovido information |                        |                    |  |  |  |  |  |  |  |
|--------------------|------------------------|--------------------|--|--|--|--|--|--|--|
| PART NUMBER        | PACKAGE <sup>(1)</sup> | BODY SIZE (NOM)    |  |  |  |  |  |  |  |
| CD54HC4511         | J (CDIP, 16)           | 24.38 mm × 6.92 mm |  |  |  |  |  |  |  |
| CD74HC4511         | N (PDIP, 16)           | 19.31 mm × 6.35 mm |  |  |  |  |  |  |  |
|                    | D (SOIC, 16)           | 9.90 mm × 3.90 mm  |  |  |  |  |  |  |  |
|                    | PW (TSSOP, 16)         | 5.00 mm × 4.40 mm  |  |  |  |  |  |  |  |
| CD74HCT4511        | N (PDIP, 16)           | 19.31 mm × 6.35 mm |  |  |  |  |  |  |  |

 For all available packages, see the orderable addendum at the end of the data sheet.





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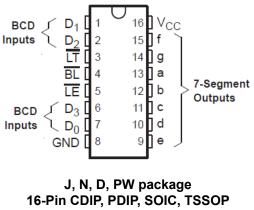
## **3 Revision History**

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| CI | hanges from Revision D (October 2003) to Revision E (August 2022)                                     | Page   |
|----|---|--------|
| •  | Updated the numbering, formatting, tables, figures, and cross-references throughout the document to r | eflect |
|    | modern data sheet standards   | 1      |



## **4** Pin Configuration and Functions



**Top View** 

## **5** Specifications

### 5.1 Absolute Maximum Ratings

over operating free-air temperature (unless otherwise noted)<sup>(1)</sup>

|                  |  |  | MIN   | MAX | UNIT |
|------------------|--|--|-------|-----|------|
| V <sub>CC</sub>  | Supply voltage                               |  | - 0.5 | 7   | V    |
| I <sub>IK</sub>  | Input diode current                          | $V_{\rm I} < -0.5$ V or $V_{\rm I} > V_{\rm CC} + 0.5$ V <sup>(1)</sup>                                    |       | ±20 | mA   |
| I <sub>OK</sub>  | Output diode current                         | $V_{\rm O} < -0.5$ V or $V_{\rm O} > V_{\rm CC} + 0.5$ V <sup>(1)</sup>                                    |       | ±20 | mA   |
| I <sub>O</sub>   | Output source or sink current per output pin | $V_{O} = 0$ to $V_{CC}$  |       | ±25 | mA   |
|                  | Continuous current through $V_{CC}$ or GND   | Continuous current through V <sub>CC</sub> or GND  |       |     |      |
| TJ               | Junction temperature                         |  |       | 150 | °C   |
| T <sub>stg</sub> | Storage temperature range                    |  | - 65  | 150 | °C   |
|                  |  | At distance $1/16 \pm 1/32$ in $(1.59 \pm 0.79)$ mm) from case for 10 s maximum                            |       | 265 | °C   |
|                  | Lead temperature (During Soldering)          | Unit inserted into a PC board (minimum thickness 1/16 in, 1.59 mm) (with solder contacting lead tips only) |       | 300 | °C   |

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability

## 5.2 Recommended Operating Conditions for 'HC4511<sup>(1)</sup>

|                 |                                 |                         | T <sub>A</sub> = 2 | T <sub>A</sub> = 25°C |      | ( = − 55°C to<br>125°C |      | T <sub>A</sub> = - 40°C to<br>85°C |    |
|-----------------|---------------------------------|-------------------------|--------------------|-----------------------|------|------------------------|------|------------------------------------|----|
|                 |                                 |                         | MIN                | NOM                   | MAX  | MIN                    | NOM  | MAX                                |    |
| V <sub>CC</sub> | Supply voltage                  |                         | 2                  | 6                     | 2    | 6                      | 2    | 6                                  | V  |
|                 |                                 | V <sub>CC</sub> = 2 V   | 1.5                |                       | 1.5  |                        | 1.5  |                                    |    |
| VIH             | High-level input voltage        | V <sub>CC</sub> = 4.5 V | 3.15               |                       | 3.15 |                        | 3.15 |                                    | V  |
|                 |                                 | V <sub>CC</sub> = 6 V   | 4.2                |                       | 4.2  |                        | 4.2  |                                    |    |
|                 |                                 | V <sub>CC</sub> = 2 V   |                    | 0.5                   |      | 0.5                    |      | 0.5                                |    |
| VIL             | Low-level input voltage         | V <sub>CC</sub> = 4.5 V |                    | 1.35                  |      | 1.35                   |      | 1.35                               | V  |
|                 |                                 | V <sub>CC</sub> = 6 V   |                    | 1.8                   |      | 1.8                    |      | 1.8                                |    |
| VI              | Input voltage                   |                         | 0                  | V <sub>CC</sub>       | 0    | V <sub>CC</sub>        | 0    | V <sub>CC</sub>                    | V  |
| Vo              | Output voltage                  |                         | 0                  | V <sub>CC</sub>       | 0    | V <sub>CC</sub>        | 0    | V <sub>CC</sub>                    | V  |
|                 |                                 | V <sub>CC</sub> = 2 V   |                    | 1000                  |      | 1000                   |      | 1000                               |    |
| tt              | Input transition rise/fall time | V <sub>CC</sub> = 4.5 V |                    | 500                   |      | 500                    |      | 500                                | ns |
|                 |                                 | V <sub>CC</sub> = 6 V   |                    | 400                   |      | 400                    |      | 400                                |    |

(1) All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report Implications of Slow or Floating SMOS Inputs, literature number SCBA004.

### 5.3 Recommended Operating Conditions for CD74HCT4511<sup>(1)</sup>

|                 |                          | T <sub>A</sub> = – 55°C | to 125°C        | T <sub>A</sub> = - 55°C 1 | to 125°C        | T <sub>A</sub> = - 40°C | UNIT            |      |
|-----------------|--------------------------|-------------------------|-----------------|---------------------------|-----------------|-------------------------|-----------------|------|
|                 |                          | MIN                     | MAX             | MIN                       | MAX             | MIN                     | MAX             | UNIT |
| V <sub>CC</sub> | Supply Voltage           | 4.5                     | 5.5             | 4.5                       | 5.5             | 4.5                     | 5.5             | V    |
| V <sub>IH</sub> | High-level input voltage | 2                       |                 | 2                         |                 | 2                       |                 | V    |
| V <sub>IL</sub> | Low-level input voltage  |                         | 0.8             |                           | 0.8             |                         | 0.8             |      |
| VI              | Input voltage            |                         | V <sub>CC</sub> |                           | V <sub>CC</sub> |                         | V <sub>CC</sub> | V    |
| Vo              | Output voltage           |                         | V <sub>CC</sub> |                           | V <sub>CC</sub> |                         | V <sub>CC</sub> | V    |



### 5.3 Recommended Operating Conditions for CD74HCT4511<sup>(1)</sup> (continued)

|    |                                       | T <sub>A</sub> = - 55°C f | to 125°C | T <sub>A</sub> = - 55°C | to 125°C | T <sub>A</sub> = - 40°C | to 85°C | UNIT |
|----|---------------------------------------|---------------------------|----------|-------------------------|----------|-------------------------|---------|------|
|    |                                       | MIN                       | MAX      | MIN                     | MAX      | MIN                     | MAX     | UNIT |
| tt | Input transition (rise and fall) time |                           | 500      |                         | 500      |                         | 500     | ns   |

 All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report Implications of Slow or Floating SMOS Inputs, literature number SCBA004.

#### **5.4 Thermal Information**

|                               |                           | D (SOIC) | N (PDIP) | PW (TSSOP) |      |
|-------------------------------|---------------------------|----------|----------|------------|------|
| THERMAL METRIC <sup>(1)</sup> |                           | 16 PINS  | 16 PINS  | 16 PINS    | UNIT |
| R <sub>θJA</sub>              | Package thermal impedance | 67       | 73       | 108        | °C/W |

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC package thermal metrics application report.

#### 5.5 'HC4511 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       |                           | TEST CONDITIONS                                     |                           | TIONS V <sub>CC</sub> |      | 25°C | $\begin{array}{c c} T_A = -55^{\circ}C \\ to 125^{\circ}C \end{array}$ |     | T <sub>A</sub> = - 40°C<br>to 85°C |      | UNIT |  |
|-----------------|---------------------------|---|---------------------------|-----------------------|------|------|--|-----|------------------------------------|------|------|--|
|                 |                           |   |                           |                       | MIN  | MAX  | MIN  | MAX | MIN                                | MAX  |      |  |
|                 |                           |   |                           | 2 V                   | 1.9  |      | 1.9  |     | 1.9                                |      |      |  |
|                 |                           |   | I <sub>OH</sub> = −20 μA  | 4.5 V                 | 4.4  |      | 4.4  |     | 4.4                                |      |      |  |
| V <sub>OH</sub> | High level output voltage | $V_{I} = V_{IH} \text{ or } V_{IL}$                 |                           | 6 V                   | 5.9  |      | 5.9  |     | 5.9                                |      | V    |  |
|                 |                           |   | I <sub>OH</sub> = −4 mA   | 4.5 V                 | 3.98 |      | 3.7  |     | 3.84                               |      |      |  |
|                 |                           |   | I <sub>OH</sub> = −5.2 mA | 6 V                   | 5.48 |      | 5.2  |     | 5.34                               |      |      |  |
|                 |                           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> |                           |                       | 2 V  |      | 0.1  |     | 0.1                                |      | 0.1  |  |
|                 |                           |   | I <sub>OL</sub> = 20 μA   | 4.5 V                 |      | 0.1  |  | 0.1 |                                    | 0.1  |      |  |
| V <sub>OL</sub> | Low level output voltage  |   |                           | 6 V                   |      | 0.1  |  | 0.1 |                                    | 0.1  | V    |  |
|                 |                           |   | I <sub>OL</sub> = 4 mA    | 4.5 V                 |      | 0.26 |  | 0.4 |                                    | 0.33 |      |  |
|                 |                           |   | I <sub>OL</sub> = 5.2 mA  | 6 V                   |      | 0.26 |  | 0.4 |                                    | 0.33 |      |  |
| Ц               | Input leakage current V   | $V_{I} = V_{CC} \text{ or } 0$                      |                           | 6 V                   |      | ±0.1 |  | ±1  |                                    | ±1   | μA   |  |
| I <sub>CC</sub> | Supply current            | $V_{I} = V_{CC} \text{ or } 0,$                     | I <sub>O</sub> = 0        | 6 V                   |      | 8    |  | 160 |                                    | 80   | μA   |  |
| Ci              | Input Capacitance         |   |                           | 2 V to<br>6 V         |      | 10   |  | 10  |                                    | 10   | pF   |  |

### 5.6 CD74HCT4511 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER                       |                            | TEST CO   | TEST CONDITIONS                                     |        | TEST CONDITIONS |     | ۲⊿   | ( = 25°C | ;   | T <sub>A</sub> = -<br>to 12 |      | T <sub>A</sub> = - 4<br>85° |  | UNIT |
|---------------------------------|----------------------------|---|---|--------|-----------------|-----|------|----------|-----|-----------------------------|------|-----------------------------|--|------|
|                                 |                            |   |   |        | MIN             | TYP | MAX  | MIN      | MAX | MIN                         | MAX  |                             |  |      |
| V                               | High level output          | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | I <sub>OH</sub> = -20 μA                            | 4.5 V  | 4.4             |     |      | 4.4      |     | 4.4                         |      |                             |  |      |
| V <sub>OH</sub>                 | voltage                    |   | I <sub>OH</sub> = -4 mA                             | 4.5 V  | 3.98            |     |      | 3.7      |     | 3.84                        |      | v                           |  |      |
| V                               | Low level output           | V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> | $\frac{I_{OL} = 20 \ \mu A}{I_{OL} = 4 \ m A} $ 4.5 | 15V    |                 |     | 0.1  |          | 0.1 |                             | 0.1  | v                           |  |      |
| V <sub>OL</sub>                 | voltage                    |   |   | 4.5 V  |                 |     | 0.26 |          | 0.4 |                             | 0.33 |                             |  |      |
| lı                              | Input leakage current<br>V | $V_{I} = V_{CC}$ to GND                             |   | 5.5 V  |                 |     | ±0.1 |          | ±1  |                             | ±1   | μA                          |  |      |
| I <sub>CC</sub>                 | Supply current             | $V_{I} = V_{CC} \text{ or } 0,$                     | I <sub>O</sub> = 0                                  | 5.5 V  |                 |     | 8    |          | 160 |                             | 80   | μA                          |  |      |
| (1)                             |                            |   | at V <sub>CC</sub> – 2.1 V 4.5 V                    |        | 100             | 540 |      | 735      |     | 675                         |      |                             |  |      |
| ΔI <sub>CC</sub> <sup>(1)</sup> | Change                     | BL, Dn inputs held                                  | d at V <sub>CC</sub> – 2.1 V                        | to 5.5 |                 | 100 | 108  |          | 147 |                             | 135  | μA                          |  |      |

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## 5.6 CD74HCT4511 Electrical Characteristics (continued)

over recommended operating free-air temperature range (unless otherwise noted)

|    | PARAMETER         | TEST CONDITIONS | V <sub>cc</sub> | T <sub>A</sub> = 25°C | ;   | T <sub>A</sub> = −55°C<br>to 125°C |     | T <sub>A</sub> = – 40°C to<br>85°C |     | UNIT |    |
|----|-------------------|-----------------|-----------------|-----------------------|-----|------------------------------------|-----|------------------------------------|-----|------|----|
|    |                   |                 |                 | MIN                   | TYP | MAX                                | MIN | MAX                                | MIN | MAX  |    |
| Ci | Input Capacitance |                 |                 |                       |     | 10                                 |     | 10                                 |     | 10   | pF |

Additional supply current per input pin, TTL inputs high, 1 unit load. For dual-supply systems, theoretical worst-case (V<sub>1</sub> = 2.4 V, V<sub>CC</sub> = 5.5 V) specification is 1.8 mA.

### 5.7 'HC4511 Timing Requirements

|                 |   | V <sub>cc</sub> | T <sub>A</sub> = 25 | °C  | T <sub>A</sub> = – 55<br>125°C |     | T <sub>A</sub> = - 40<br>85°C |     | UNIT |
|-----------------|---|-----------------|---------------------|-----|--------------------------------|-----|-------------------------------|-----|------|
|                 |   |                 | MIN                 | MAX | MIN                            | MAX | MIN                           | MAX |      |
|                 |   | 2 V             | 80                  |     | 120                            |     | 100                           |     |      |
| t <sub>W</sub>  | Pulse duration, $\overline{LE}$ low                           | 4.5 V           | 16                  |     | 24                             |     | 20                            |     | ns   |
|                 |   | 6 V             | 14                  |     | 20                             |     | 17                            |     |      |
|                 |   | 2 V             | 60                  |     | 90                             |     | 75                            |     |      |
| t <sub>su</sub> | Setup time, BCD inputs before $\overline{\text{LE}} \uparrow$ | 4.5 V           | 12                  |     | 18                             |     | 15                            |     | ns   |
|                 |   | 6 V             | 10                  |     | 15                             |     | 13                            |     |      |
|                 |   | 2 V             | 3                   |     | 3                              |     | 3                             |     |      |
| t <sub>h</sub>  | Hold time, BCD inputs before $\overline{\text{LE}} \uparrow$  | 4.5 V           | 3                   |     | 3                              |     | 3                             |     | ns   |
|                 |   | 6 V             | 3                   |     | 3                              |     | 3                             |     |      |

### **5.8 Switching Characteristics**

| PARAMETER       | FROM<br>(INPUT) | TO       | LOAD<br>CAPACITANCE    | V <sub>cc</sub>        | -     | T <sub>A</sub> = 25°C | :   | T <sub>A</sub> = – 55°C TO<br>125°C | T <sub>A</sub> = - 40°C TO<br>85°C | UNIT |    |
|-----------------|-----------------|----------|------------------------|------------------------|-------|-----------------------|-----|-------------------------------------|------------------------------------|------|----|
|                 | (INPUT)         | (001201) | CAPACITANCE            |                        | MIN   | TYP                   | MAX | MIN MAX                             | MIN MAX                            |      |    |
|                 |                 |          |                        | 2 V                    |       |                       | 300 | 450                                 | 375                                |      |    |
|                 | D <sub>n</sub>  | Output   | C <sub>L</sub> = 50 pF | 4.5 V                  |       |                       | 60  | 90                                  | 75                                 | ]    |    |
|                 | D <sub>n</sub>  | Output   |                        | 6 V                    |       |                       | 51  | 77                                  | 64                                 |      |    |
|                 |                 |          | C <sub>L</sub> = 15 pF | 5 V                    |       | 25                    |     |                                     |                                    |      |    |
|                 |                 |          |                        | 2 V                    |       |                       | 270 | 405                                 | 340                                |      |    |
|                 | LE              | Output   | C <sub>L</sub> = 50 pF | 4.5 V                  |       |                       | 54  | 81                                  | 68                                 |      |    |
|                 | LE              | Output   |                        | 6 V                    |       |                       | 46  | 69                                  | 58                                 |      |    |
| +               |                 |          | C <sub>L</sub> = 15 pF | 5 V                    |       | 23                    |     |                                     |                                    |      |    |
| t <sub>pd</sub> |                 |          |                        | 2 V                    |       |                       | 220 | 330                                 | 275                                | ns   |    |
|                 | BL              | Quitaut  | C <sub>L</sub> = 50 pF | C <sub>L</sub> = 50 pF | 4.5 V |                       |     | 44                                  | 66                                 | 55   |    |
|                 | DL              | Output   |                        | 6 V                    |       |                       | 37  | 56                                  | 47                                 |      |    |
|                 |                 |          | C <sub>L</sub> = 15 pF |                        |       | 18                    |     |                                     |                                    |      |    |
|                 |                 |          |                        | 2 V                    |       |                       | 160 | 240                                 | 200                                |      |    |
|                 | LT              | Output   | C <sub>L</sub> = 50 pF | 4.5 V                  |       |                       | 32  | 48                                  | 40                                 |      |    |
|                 | LI              | Output   |                        | 6 V                    |       |                       | 27  | 41                                  | 34                                 |      |    |
|                 |                 |          | C <sub>L</sub> = 15 pF | 5 V                    |       | 13                    |     |                                     |                                    |      |    |
|                 |                 |          |                        | 2 V                    |       |                       | 75  | 110                                 | 95                                 |      |    |
| tt              |                 | Any      | C <sub>L</sub> = 50 pF | C <sub>L</sub> = 50 pF | 4.5 V |                       |     | 15                                  | 22                                 | 19   | ns |
|                 |                 |          |                        | 6 V                    |       |                       | 13  | 19                                  | 16                                 |      |    |



#### 5.9 CD74HCT4511 Timing Requirements

|                 |  | T <sub>A</sub> = 25 | °C  | T <sub>A</sub> = - 55°C<br>°C |     | T <sub>A</sub> = – 40°C | TO 85°C | UNIT |
|-----------------|--|---------------------|-----|-------------------------------|-----|-------------------------|---------|------|
|                 |  | MIN                 | MAX | MIN                           | MAX | MIN                     | MAX     |      |
| t <sub>w</sub>  | Pulse duration, LE low                                       | 16                  |     | 24                            |     | 20                      |         | ns   |
| t <sub>su</sub> | Setup time, BCD inputs before $\overline{\text{LE}}\uparrow$ | 16                  |     | 24                            |     | 20                      |         | ns   |
| t <sub>h</sub>  | Hold time, BCD inputs before $\overline{\text{LE}}\uparrow$  | 5                   |     | 5                             |     | 5                       |         | ns   |

over operating free-air temperature range (unless otherwise noted)

#### 5.10 CD74HCT4511 Switching Characteristics

| PARAMETER       | FROM<br>(INPUT) | TO<br>(OUTPUT) |                        | V <sub>cc</sub> | т   | <sub>A</sub> = 25°C | ;   | T <sub>A</sub> = - 5<br>125 |     | T <sub>A</sub> = - 4<br>85° |     | UNIT       |
|-----------------|-----------------|----------------|------------------------|-----------------|-----|---------------------|-----|-----------------------------|-----|-----------------------------|-----|------------|
|                 |                 |                | CAFACITANCE            |                 | MIN | TYP                 | MAX | MIN                         | MAX | MIN                         | MAX |            |
|                 | D <sub>n</sub>  | Output         | C <sub>L</sub> = 50 pF | 4.5 V           |     |                     | 60  |                             | 90  |                             | 75  |            |
|                 |                 |                | C <sub>L</sub> = 15 pF | 5 V             |     | 25                  |     |                             |     |                             |     |            |
|                 | LE              | Output         | C <sub>L</sub> = 50 pF | 4.5 V           |     |                     | 54  |                             | 81  |                             | 68  |            |
|                 |                 |                | C <sub>L</sub> = 15 pF | 5 V             |     | 23                  |     |                             |     |                             |     | <b>n</b> 0 |
| t <sub>pd</sub> | BL              | Output         | C <sub>L</sub> = 50 pF | 4.5 V           |     |                     | 44  |                             | 66  |                             | 55  | ns         |
|                 |                 |                | C <sub>L</sub> = 15 pF | 5 V             |     | 18                  |     |                             |     |                             |     |            |
|                 | LT              | Output         | C <sub>L</sub> = 50 pF | 4.5 V           |     |                     | 33  |                             | 50  |                             | 41  |            |
|                 |                 |                | C <sub>L</sub> = 15 pF | 5 V             |     | 13                  |     |                             |     |                             |     |            |
| tt              |                 | Any            | C <sub>L</sub> = 50 pF | 4.5 V           |     |                     | 15  |                             | 22  |                             | 19  | ns         |

#### **5.11 Operating Characteristics**

|     | PARAMETER <sup>(1)</sup>      |             | ТҮР | UNIT |
|-----|-------------------------------|-------------|-----|------|
| C   | Power dissipation capacitance | 'HC4511     | 114 | ъĘ   |
| Cpd |                               | CD74HCT4511 | 110 | р⊢   |

(1)  $C_{pd}$  is used to determine the dynamic power consumption, per package.

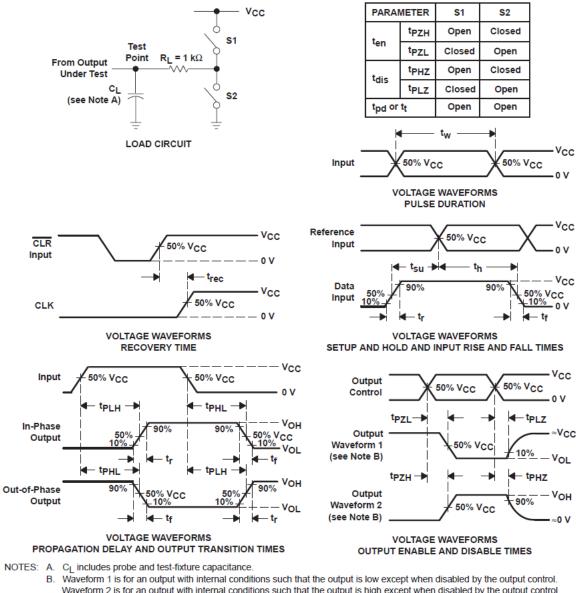
 $P_{D} = C_{pd}V_{CC} {}^{2}f_{i} + \Sigma C_{L} V_{CC} {}^{2}f_{o} \text{ where:}$   $f_{i} = \text{input frequency}$ 

 $f_o = output frequency$ 

C<sub>L</sub> = output load capacitance

 $V_{CC}$  = supply voltage

### **6** Parameter Measurement Information

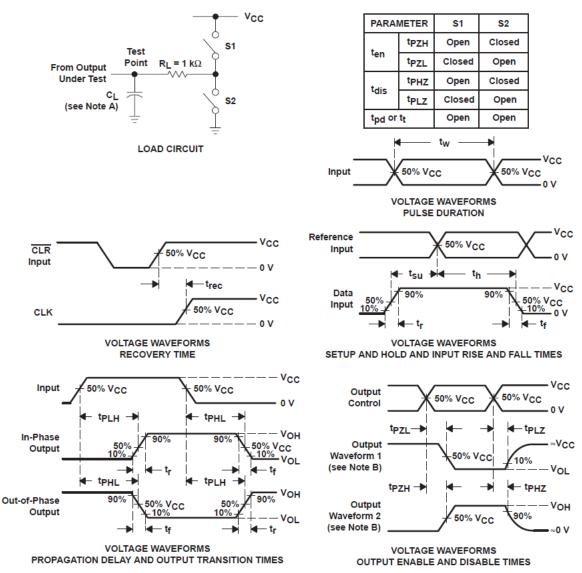


Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following

- characteristics: PRR  $\leq$  1 MHz, Z<sub>O</sub> = 50  $\Omega$ , t<sub>f</sub> = 6 ns, t<sub>f</sub> = 6 ns.
- D. For clock inputs, f<sub>max</sub> is measured with the input duty cycle at 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. tpLz and tpHz are the same as tdis.
- G. tpzL and tpzH are the same as ten.
- H.  $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .

#### Figure 6-1. 'HC4511





NOTES: A. CL includes probe and test-fixture capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
   C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z<sub>O</sub> = 50 Ω, t<sub>f</sub> = 6 ns. t<sub>f</sub> = 6 ns.
- D. For clock inputs, f<sub>max</sub> is measured with the input duty cycle at 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}.$
- G. tpzL and tpzH are the same as ten.
- H. tpLH and tpHL are the same as tpd.

#### Figure 6-2. CD74HCT4511



## 7 Detailed Description

### 7.1 Overview

The CD54HC4511, CD74HC4511, and CD74HCT4511 are BCD-to-7 segment latch/decoder/drivers with four address inputs ( $D_0-D_3$ ), an active-low blanking ( $\overline{BL}$ ) input, lamp-test ( $\overline{LT}$ ) input, and a latch-enable ( $\overline{LE}$ ) input that, when high, enables the latches to store the BCD inputs. When  $\overline{LE}$  is low, the latches are disabled, making the outputs transparent to the BCD inputs.

These devices have standard-size output transistors, but are capable of sourcing (at standard  $V_{OH}$  levels) up to 7.5 mA at 4.5 V. The HC types can supply up to 10 mA at 6 V.

#### 7.2 Functional Block Diagram

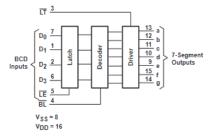




Table 7.4. Europhians Table

#### 7.3 Device Functional Modes

|    |    |    |                     |                |                | lable 7        | -1. Fun | ction T | able |     |                      |   |   |         |
|----|----|----|---------------------|----------------|----------------|----------------|---------|---------|------|-----|----------------------|---|---|---------|
|    |    | I  | NPUTS <sup>(1</sup> | )              |                |                |         |         |      | OUT | rputs <sup>(2)</sup> |   |   |         |
| LE | BL | LT | D <sub>3</sub>      | D <sub>2</sub> | D <sub>1</sub> | D <sub>0</sub> | а       | b       | с    | d   | е                    | f | g | DISPLAY |
| Х  | Х  | L  | Х                   | Х              | Х              | Х              | Н       | Н       | Н    | н   | н                    | Н | Н | 8       |
| Х  | L  | Н  | Х                   | Х              | Х              | Х              | L       | L       | L    | L   | L                    | L | L | Blank   |
| L  | н  | Н  | L                   | L              | L              | L              | Н       | Н       | Н    | Н   | н                    | Н | L | 0       |
| L  | н  | Н  | L                   | L              | L              | н              | L       | Н       | Н    | L   | L                    | L | L | 1       |
| L  | н  | Н  | L                   | L              | н              | L              | н       | н       | L    | н   | н                    | L | Н | 2       |
| L  | н  | Н  | L                   | L              | н              | н              | н       | Н       | н    | н   | L                    | L | Н | 3       |
| L  | н  | Н  | L                   | Н              | L              | L              | L       | Н       | Н    | L   | L                    | Н | Н | 4       |
| L  | н  | Н  | L                   | Н              | L              | Н              | Н       | L       | Н    | Н   | L                    | Н | Н | 5       |
| L  | н  | Н  | L                   | Н              | Н              | L              | L       | L       | Н    | н   | н                    | Н | Н | 6       |
| L  | н  | Н  | L                   | Н              | Н              | н              | Н       | Н       | Н    | L   | L                    | L | L | 7       |
| L  | н  | Н  | Н                   | L              | L              | L              | Н       | Н       | Н    | н   | н                    | Н | Н | 8       |
| L  | н  | Н  | н                   | L              | L              | н              | н       | н       | Н    | L   | L                    | н | Н | 9       |
| L  | н  | н  | Н                   | L              | н              | L              | L       | L       | L    | L   | L                    | L | L | Blank   |
| L  | н  | Н  | н                   | L              | н              | н              | L       | L       | L    | L   | L                    | L | L | Blank   |
| L  | н  | Н  | н                   | Н              | L              | L              | L       | L       | L    | L   | L                    | L | L | Blank   |
| L  | н  | Н  | Н                   | Н              | L              | Н              | L       | L       | L    | L   | L                    | L | L | Blank   |
| L  | н  | Н  | Н                   | Н              | Н              | L              | L       | L       | L    | L   | L                    | L | L | Blank   |
| L  | н  | Н  | Н                   | Н              | Н              | Н              | L       | L       | L    | L   | L                    | L | L | Blank   |
| Н  | н  | Н  | Х                   | Х              | Х              | Х              | t       | t       | t    | t   | t                    | t | t | t       |

(1) H = High Voltage Level, L = Low Voltage Level, X = Don't caret = Depends on BCD code previously applied when LE = LNOTE: Display is blank for all illegal input codes (BCD > HLLH).

(2) H = Driving High, L = Driving Low, Z = High Impedance State



## 8 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in the *Recommended Operating Conditions*. Each  $V_{CC}$  terminal should have a good bypass capacitor to prevent power disturbance. A 0.1- $\mu$ F capacitor is recommended for this device. It is acceptable to parallel multiple bypass caps to reject different frequencies of noise. The 0.1- $\mu$ F and 1- $\mu$ F capacitors are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

#### 9 Layout

#### 9.1 Layout Guidelines

When using multiple-input and multiple-channel logic devices inputs must not ever be left floating. In many cases, functions or parts of functions of digital logic devices are unused; for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such unused input pins must not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. All unused inputs of digital logic devices must be connected to a logic high or logic low voltage, as defined by the input voltage specifications, to prevent them from floating. The logic level that must be applied to any particular unused input depends on the function of the device. Generally, the inputs are tied to GND or  $V_{CC}$ , whichever makes more sense for the logic function or is more convenient.



## **10 Device and Documentation Support**

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

#### **10.1 Receiving Notification of Documentation Updates**

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

#### **10.2 Support Resources**

TI E2E<sup>™</sup> support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

#### 10.3 Trademarks

TI E2E<sup>™</sup> is a trademark of Texas Instruments. All trademarks are the property of their respective owners.

#### **10.4 Electrostatic Discharge Caution**



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### 10.5 Glossary

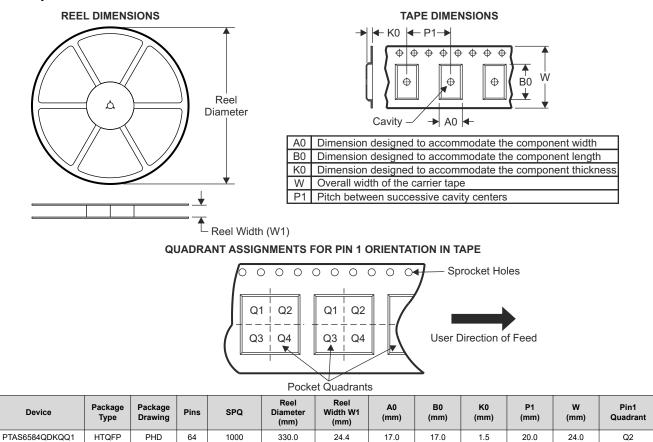
TI Glossary This glossary lists and explains terms, acronyms, and definitions.

### 11 Mechanical, Packaging, and Orderable Information

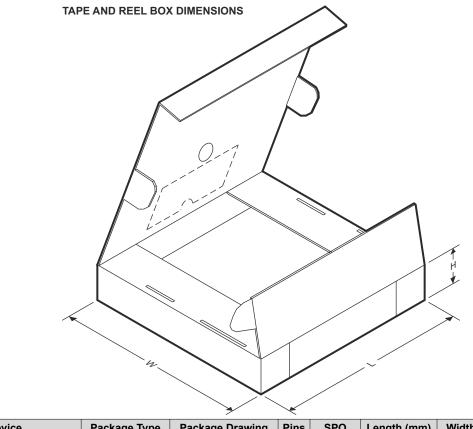
The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



#### 11.1 Tape and Reel Information

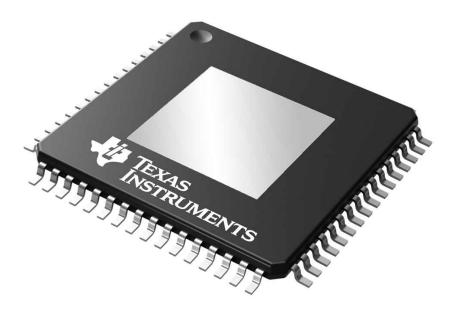






| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| PTAS6584QPHDRQ1 | HTQFP        | PHD             | 64   | 1000 | 350.0       | 350.0      | 43.0        |

## 11.2 Mechanical Data

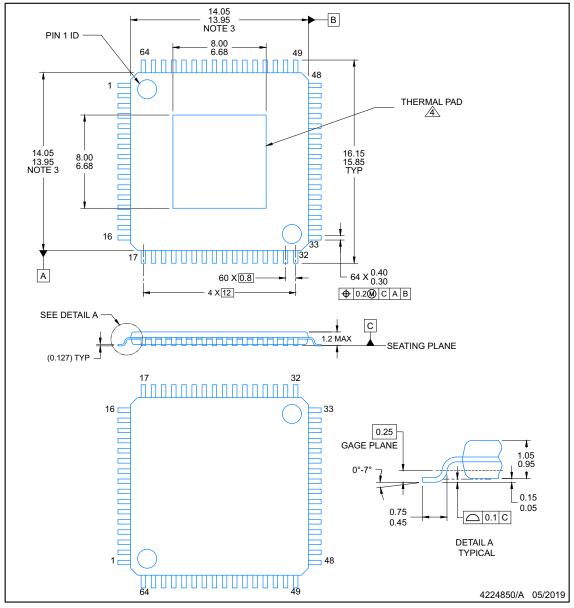




## **PHD0064B**

## PACKAGE OUTLINE HTQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per side.
- 4. See technical brief. PowerPad Thermally Enhanced Package, Texas Instruments Literature No. SLMA002 (www.ti.com/lit/slma002) and SLMA004 (www.ti.com/lit/slma004) for information regarding recommended board layout.



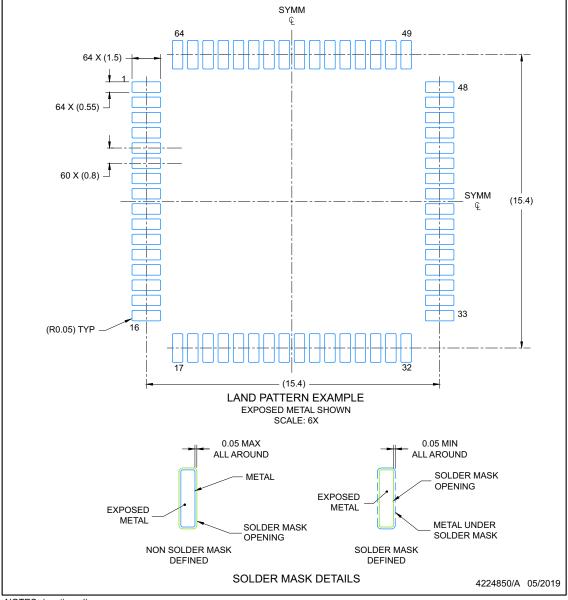


## EXAMPLE BOARD LAYOUT

## **PHD0064B**

## PLASTIC QUAD FLATPACK

HTQFP - 1.2 mm max height



NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
- 7. Vias are optional depending on application, refer to device data sheet. It is recommended that vias under paste be filled, plugged or tented.



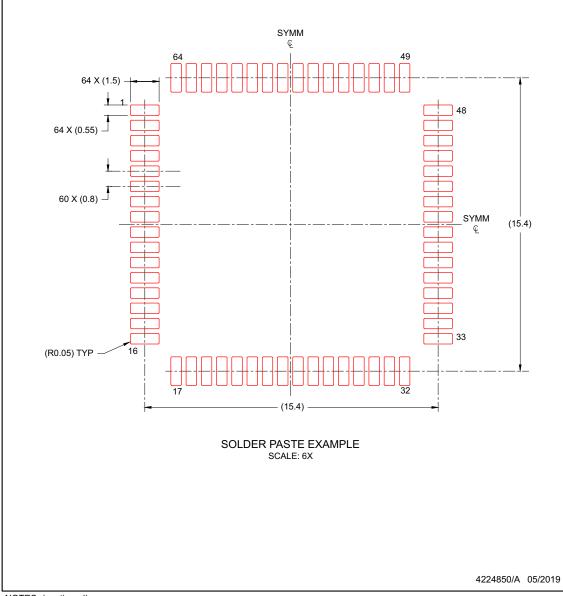


## PHD0064B

# EXAMPLE STENCIL DESIGN

## HTQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



- NOTES: (continued)
- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.





## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)     | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5)         | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|---------------------|--------------------------------------|----------------------|--------------|---------------------------------|---------|
| 5962-8773301EA   | ACTIVE        | CDIP         | J                  | 16   | 25             | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-8773301EA<br>CD54HC4511F3A | Samples |
| CD54HC4511F3A    | ACTIVE        | CDIP         | J                  | 16   | 25             | Non-RoHS<br>& Green | SNPB                                 | N / A for Pkg Type   | -55 to 125   | 5962-8773301EA<br>CD54HC4511F3A | Samples |
| CD74HC4511E      | ACTIVE        | PDIP         | Ν                  | 16   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | -55 to 125   | CD74HC4511E                     | Samples |
| CD74HC4511EE4    | ACTIVE        | PDIP         | N                  | 16   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | -55 to 125   | CD74HC4511E                     | Samples |
| CD74HC4511M      | OBSOLETE      | SOIC         | D                  | 16   |                | TBD                 | Call TI                              | Call TI              | -55 to 125   | HC4511M                         |         |
| CD74HC4511M96    | ACTIVE        | SOIC         | D                  | 16   | 2500           | RoHS & Green        | NIPDAU   SN                          | Level-1-260C-UNLIM   | -55 to 125   | HC4511M                         | Samples |
| CD74HC4511M96G4  | ACTIVE        | SOIC         | D                  | 16   | 2500           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | HC4511M                         | Samples |
| CD74HC4511PWR    | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | HJ4511                          | Samples |
| CD74HC4511PWRE4  | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | HJ4511                          | Samples |
| CD74HC4511PWRG4  | ACTIVE        | TSSOP        | PW                 | 16   | 2000           | RoHS & Green        | NIPDAU                               | Level-1-260C-UNLIM   | -55 to 125   | HJ4511                          | Samples |
| CD74HC4511PWT    | OBSOLETE      | TSSOP        | PW                 | 16   |                | TBD                 | Call TI                              | Call TI              | -55 to 125   | HJ4511                          |         |
| CD74HCT4511E     | ACTIVE        | PDIP         | Ν                  | 16   | 25             | RoHS & Green        | NIPDAU                               | N / A for Pkg Type   | -55 to 125   | CD74HCT4511E                    | Samples |

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.



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## PACKAGE OPTION ADDENDUM

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF CD54HC4511, CD74HC4511 :

Catalog : CD74HC4511

• Military : CD54HC4511

NOTE: Qualified Version Definitions:

- Catalog TI's standard catalog product
- Military QML certified for Military and Defense Applications



Texas

STRUMENTS

## TAPE AND REEL INFORMATION





#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal |                 |                    |    |      |                          |                          |            |            |            |            |           |                  |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device                      | Package<br>Type | Package<br>Drawing |    | SPQ  | Reel<br>Diameter<br>(mm) | Reel<br>Width<br>W1 (mm) | A0<br>(mm) | B0<br>(mm) | K0<br>(mm) | P1<br>(mm) | W<br>(mm) | Pin1<br>Quadrant |
| CD74HC4511M96               | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4511M96G4             | SOIC            | D                  | 16 | 2500 | 330.0                    | 16.4                     | 6.5        | 10.3       | 2.1        | 8.0        | 16.0      | Q1               |
| CD74HC4511PWR               | TSSOP           | PW                 | 16 | 2000 | 330.0                    | 12.4                     | 6.9        | 5.6        | 1.6        | 8.0        | 12.0      | Q1               |



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# PACKAGE MATERIALS INFORMATION

8-Apr-2025



\*All dimensions are nominal

| Device          | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-----------------|--------------|-----------------|------|------|-------------|------------|-------------|
| CD74HC4511M96   | SOIC         | D               | 16   | 2500 | 356.0       | 356.0      | 35.0        |
| CD74HC4511M96G4 | SOIC         | D               | 16   | 2500 | 356.0       | 356.0      | 35.0        |
| CD74HC4511PWR   | TSSOP        | PW              | 16   | 2000 | 356.0       | 356.0      | 35.0        |

## TEXAS INSTRUMENTS

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## TUBE



## - B - Alignment groove width

#### \*All dimensions are nominal

| Device        | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (µm) | B (mm) |
|---------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| CD74HC4511E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4511E   | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4511EE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HC4511EE4 | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HCT4511E  | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| CD74HCT4511E  | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



# **PW0016A**



# **PACKAGE OUTLINE**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-153.



# PW0016A

# **EXAMPLE BOARD LAYOUT**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# PW0016A

# **EXAMPLE STENCIL DESIGN**

## TSSOP - 1.2 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

9. Board assembly site may have different recommendations for stencil design.



<sup>8.</sup> Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



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